

82C55A

CMOS Programmable Peripheral Interface

June 1998

Features

- Pin Compatible with NMOS 8255A
- 24 Programmable I/O Pins
- Fully TTL Compatible
- High Speed, No "Wait State" Operation with 5MHz and 8MHz 80C86 and 80C88
- Direct Bit Set/Reset Capability
- Enhanced Control Word Read Capability
- L7 Process
- 2.5mA Drive Capability on All I/O Ports
- Low Standby Power (ICCSB)10uA

Ordering Information

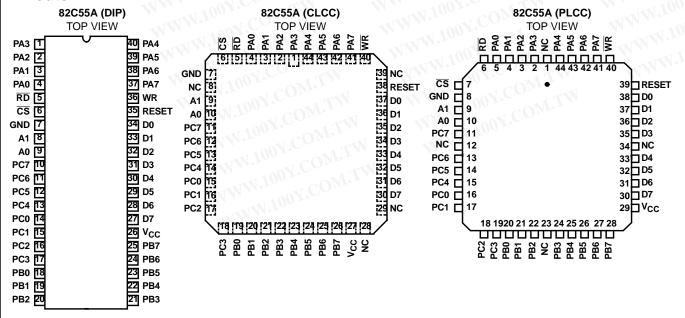
PART NUMBERS		CO_{Mr}	TEMPERATURE	PKG.	
5MHz	8MHz	PACKAGE	RANGE	NO.	
CP82C55A-5	CP82C55A	40 Ld PDIP	0°C to 70°C	E40.6	
IP82C55A-5	IP82C55A	40 La PDIP	-40°C to 85°C	E40.6	
CS82C55A-5	CS82C55A	44 Ld PLCC	0°C to 70°C	N44.65	
IS82C55A-5	IS82C55A	44 Lu PLCC	-40°C to 85°C	N44.65	
CD82C55A-5	CD82C55A	401.127.00	0°C to 70°C	F40.6	
ID82C55A-5	ID82C55A	40 Ld CERDIP	-40°C to 85°C	F40.6	
MD82C55A-5/B	MD82C55A/B	CLINDIF	-55°C to 125°C	F40.6	
8406601QA	8406602QA	SMD#	COM	F40.6	
MR82C55A-5/B	MR82C55A/B	44 Pad CLCC	-55°C to 125°C	J44.A	
8406601XA	8406602XA	SMD#	OM.T.	J44.A	

Description

The Intersil 82C55A is a high performance CMOS version of the industry standard 8255A and is manufactured using a self-aligned silicon gate CMOS process (Scaled SAJI IV). It is a general purpose programmable I/O device which may be used with many different microprocessors. There are 24 I/O pins which may be individually programmed in 2 groups of 12 and used in 3 major modes of operation. The high performance and industry standard configuration of the 82C55A make it compatible with the 80C86, 80C88 and other microprocessors.

Static CMOS circuit design insures low operating power. TTL compatibility over the full military temperature range and bus hold circuitry eliminate the need for pull-up resistors. The Intersil advanced SAJI process results in performance equal to or greater than existing functionally equivalent products at a fraction of the power.

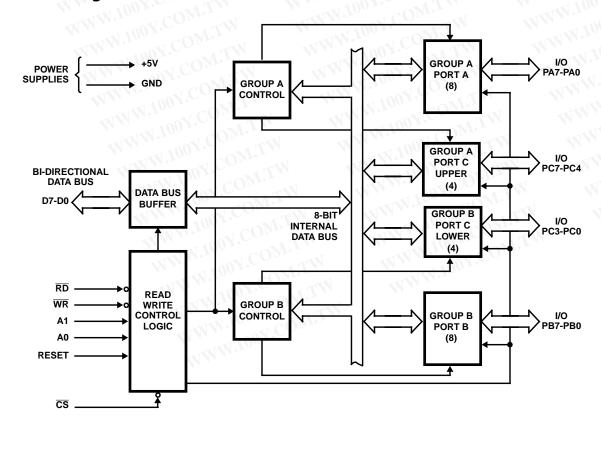
Pinouts



Pin Description

SYMBOL	PIN NUMBER	TYPE	DESCRIPTION			
Vcc	26	WWW.10	$V_{\mbox{CC}}\colon$ The +5V power supply pin. A $0.1\mu\mbox{F}$ capacitor between pins 26 and 7 is recommended for decoupling.			
GND	7		GROUND			
D0-D7	27-34	1/0	DATA BUS: The Data Bus lines are bidirectional three-state pins connected to the system data bus.			
RESET	35	MM	RESET: A high on this input clears the control register and all ports (A, B, C) are set to the input mode with the "Bus Hold" circuitry turned on.			
CS	6	1 111	CHIP SELECT: Chip select is an active low input used to enable the 82C55A onto the Data Bus for CPU communications.			
RD RD	Y.CO5	N Y	READ: Read is an active low input control signal used by the CPU to read status information or data via the data bus.			
WR	36	W I	WRITE: Write is an active low input control signal used by the CPU to load cowords and data into the 82C55A.			
A0-A1	8, 9	I.TW	ADDRESS: These input signals, in conjunction with the RD and WR inputs, control the selection of one of the three ports or the control word register. A0 and A1 are normally connected to the least significant bits of the Address Bus A0, A1.			
PA0-PA7	1-4, 37-40	I/O	PORT A: 8-bit input and output port. Both bus hold high and bus hold low circuits present on this port.			
PB0-PB7	18-25	I/O	PORT B: 8-bit input and output port. Bus hold high circuitry is present on this port.			
PC0-PC7	10-17	I/O	PORT C: 8-bit input and output port. Bus hold circuitry is present on this port.			

Functional Diagram



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Functional Description

Data Bus Buffer

This three-state bi-directional 8-bit buffer is used to interface the 82C55A to the system data bus. Data is transmitted or received by the buffer upon execution of input or output instructions by the CPU. Control words and status information are also transferred through the data bus buffer.

Read/Write and Control Logic

The function of this block is to manage all of the internal and external transfers of both Data and Control or Status words. It accepts inputs from the CPU Address and Control busses and in turn, issues commands to both of the Control Groups.

(CS) Chip Select. A "low" on this input pin enables the communcation between the 82C55A and the CPU.

(RD) Read. A "low" on this input pin enables 82C55A to send the data or status information to the CPU on the data bus. In essence, it allows the CPU to "read from" the 82C55A.

(WR) Write. A "low" on this input pin enables the CPU to write data or control words into the 82C55A.

(A0 and A1) Port Select 0 and Port Select 1. These input signals, in conjunction with the RD and WR inputs, control the selection of one of the three ports or the control word register. They are normally connected to the least significant bits of the address bus (A0 and A1).

82C55A BASIC OPERATION

A1	Α0	RD	wr	cs	INPUT OPERATION (READ)
0	0	0	1	0	Port A → Data Bus
0	1	0	11	0	Port B → Data Bus
1	0	0	1 🔻	0	Port C → Data Bus
1	1	0	1	0	Control Word → Data Bus
				W	OUTPUT OPERATION (WRITE)
0	0	1	0	0	Data Bus → Port A
0	1	1	0	0	Data Bus → Port B
1	0	1	0	0	Data Bus → Port C
1	1	1	0	0	Data Bus → Control
		-	-	-	DISABLE FUNCTION
Х	Х	Х	х	1	Data Bus → Three-State
Х	Х	1	1	0	Data Bus → Three-State

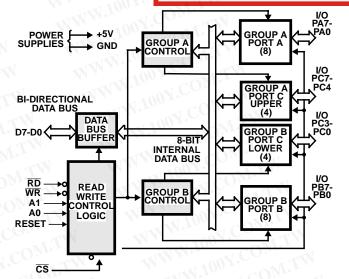


FIGURE 1. 82C55A BLOCK DIAGRAM. DATA BUS BUFFER, READ/WRITE, GROUP A & B CONTROL LOGIC FUNCTIONS

(RESET) Reset. A "high" on this input initializes the control register to 9Bh and all ports (A, B, C) are set to the input mode. "Bus hold" devices internal to the 82C55A will hold the I/O port inputs to a logic "1" state with a maximum hold current of $400\mu A$.

Group A and Group B Controls

The functional configuration of each port is programmed by the systems software. In essence, the CPU "outputs" a control word to the 82C55A. The control word contains information such as "mode", "bit set", "bit reset", etc., that initializes the functional configuration of the 82C55A.

Each of the Control blocks (Group A and Group B) accepts "commands" from the Read/Write Control logic, receives "control words" from the internal data bus and issues the proper commands to its associated ports.

Control Group A - Port A and Port C upper (C7 - C4)

Control Group B - Port B and Port C lower (C3 - C0)

The control word register can be both written and read as shown in the "Basic Operation" table. Figure 4 shows the control word format for both Read and Write operations. When the control word is read, bit D7 will always be a logic "1", as this implies control word mode information.

Ports A, B, and C

The 82C55A contains three 8-bit ports (A, B, and C). All can be configured to a wide variety of functional characteristics by the system software but each has its own special features or "personality" to further enhance the power and flexibility of the 82C55A.

Port A One 8-bit data output latch/buffer and one 8-bit data input latch. Both "pull-up" and "pull-down" bus-hold devices are present on Port A. See Figure 2A.

Port B One 8-bit data input/output latch/buffer and one 8-bit data input buffer. See Figure 2B.

Port C One 8-bit data output latch/buffer and one 8-bit data input buffer (no latch for input). This port can be divided into two 4-bit ports under the mode control. Each 4-bit port contains a 4-bit latch and it can be used for the control signal output and status signal inputs in conjunction with ports A and B. See Figure 2B.

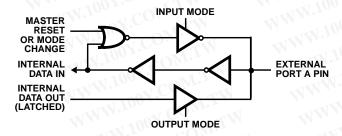


FIGURE 2A. PORT A BUS-HOLD CONFIGURATION

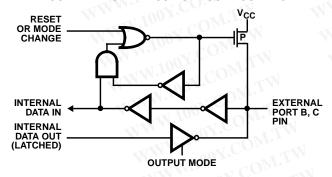


FIGURE 2B. PORT B AND C BUS-HOLD CONFIGURATION

FIGURE 2. BUS-HOLD CONFIGURATION

Operational Description

Mode Selection

There are three basic modes of operation than can be selected by the system software:

Mode 0 - Basic Input/Output

Mode 1 - Strobed Input/Output

Mode 2 - Bi-directional Bus

When the reset input goes "high", all ports will be set to the input mode with all 24 port lines held at a logic "one" level by internal bus hold devices. After the reset is removed, the 82C55A can remain in the input mode with no additional initialization required. This eliminates the need to pullup or pull-down resistors in all-CMOS designs. The control word

register will contain 9Bh. During the execution of the system program, any of the other modes may be selected using a single output instruction. This allows a single 82C55A to service a variety of peripheral devices with a simple software maintenance routine. Any port programmed as an output port is initialized to all zeros when the control word is written.

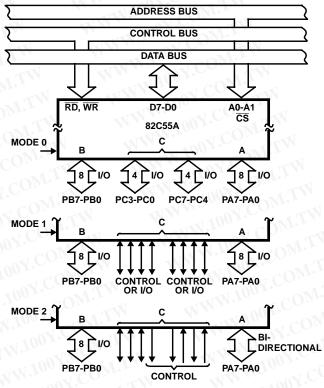


FIGURE 3. BASIC MODE DEFINITIONS AND BUS INTERFACE

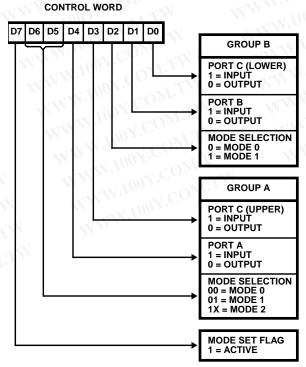


FIGURE 4. MODE DEFINITION FORMAT

82C55A

The modes for Port A and Port B can be separately defined, while Port C is divided into two portions as required by the Port A and Port B definitions. All of the output registers, including the status flip-flops, will be reset whenever the mode is changed. Modes may be combined so that their functional definition can be "tailored" to almost any I/O structure. For instance: Group B can be programmed in Mode 0 to monitor simple switch closings or display computational results, Group A could be programmed in Mode 1 to monitor a keyboard or tape reader on an interrupt-driven basis.

The mode definitions and possible mode combinations may seem confusing at first, but after a cursory review of the complete device operation a simple, logical I/O approach will surface. The design of the 82C55A has taken into account things such as efficient PC board layout, control signal definition vs. PC layout and complete functional flexibility to support almost any peripheral device with no external logic. Such design represents the maximum use of the available pins.

Single Bit Set/Reset Feature (Figure 5)

Any of the eight bits of Port C can be Set or Reset using a single Output instruction. This feature reduces software requirements in control-based applications.

When Port C is being used as status/control for Port A or B, these bits can be set or reset by using the Bit Set/Reset operation just as if they were output ports.

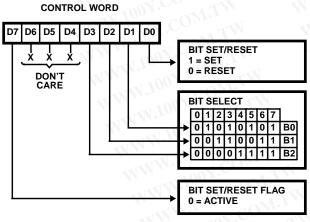


FIGURE 5. BIT SET/RESET FORMAT

Interrupt Control Functions

When the 82C55A is programmed to operate in mode 1 or mode 2, control signals are provided that can be used as interrupt request inputs to the CPU. The interrupt request signals, generated from port C, can be inhibited or enabled by setting or resetting the associated INTE flip-flop, using the bit set/reset function of port C.

This function allows the programmer to enable or disable a CPU interrupt by a specific I/O device without affecting any other device in the interrupt structure.

INTE Flip-Flop Definition

(BIT-SET)-INTE is SET - Interrupt Enable

(BIT-RESET)-INTE is Reset - Interrupt Disable

NOTE: All Mask flip-flops are automatically reset during mode selection and device Reset.

Operating Modes

Mode 0 (Basic Input/Output). This functional configuration provides simple input and output operations for each of the three ports. No handshaking is required, data is simply written to or read from a specific port.

Mode 0 Basic Functional Definitions:

- Two 8-bit ports and two 4-bit ports
- · Any Port can be input or output
- · Outputs are latched
- · Input are not latched
- 16 different Input/Output configurations possible

MODE 0 PORT DEFINITION

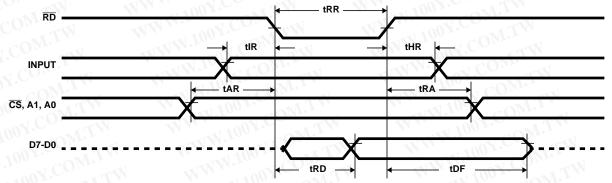
	YO.		В	GRO	UP A		GRO	UP B
D4	D3	D1	D0	PORT A	PORT C PORT A (Upper)		PORT B	PORTC (Lower)
0	0	0	0	Output	Output	0	Output	Output
0	0	0	1	Output	Output	1	Output	Input
0	0	1	0	Output	Output	2	Input	Output
0	0	10	1	Output	Output	3	Input	Input
0	1	0	0	Output	Input	4	Output	Output
0	1	0	17.	Output	Input	5	Output	Input
0	1	11	0	Output	Input	6	Input	Output
0	1	1	1	Output	Input	7	Input	Input
1	0	0	0	Input	Output	8	Output	Output
1	0	0	11	Input	Output	9	Output	Input
1	0	1	0	Input	Output	10	Input	Output
1	0	1	1	Input	Output	11	Input	Input
1	1	0	0	Input	Input	12	Output	Output
1	1	0	1	Input	Input	13	Output	Input
1	1	1	0	Input	Input	14	Input	Output
1	1	1	1	Input	Input	15	Input	Input

82C55A

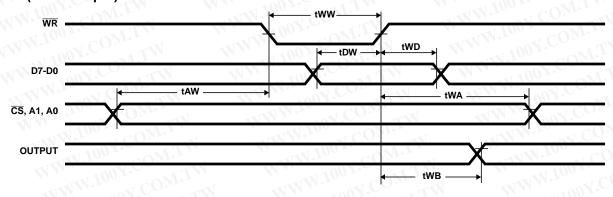
勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

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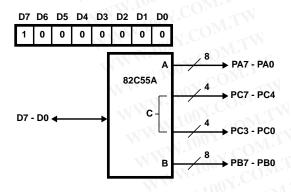


Mode 0 (Basic Output)

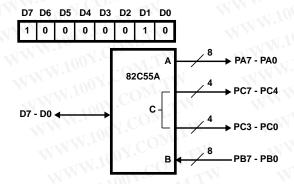


Mode 0 Configurations

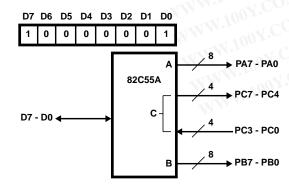
CONTROL WORD #0



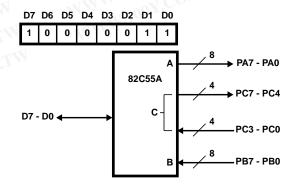
CONTROL WORD #2



CONTROL WORD #1



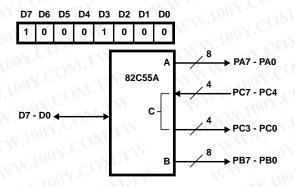
CONTROL WORD #3



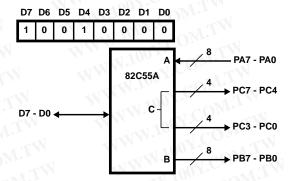
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Mode 0 Configurations (Continued)

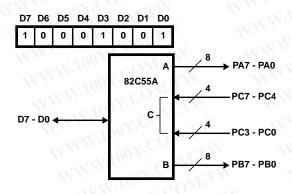
CONTROL WORD #4



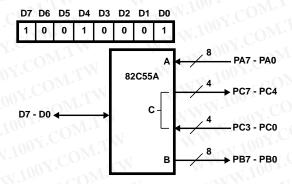
CONTROL WORD #8



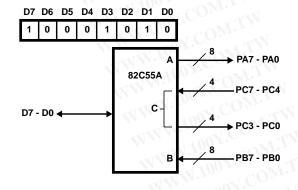
CONTROL WORD #5



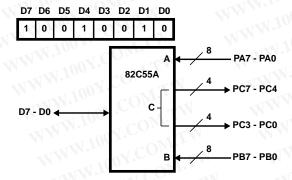
CONTROL WORD #9



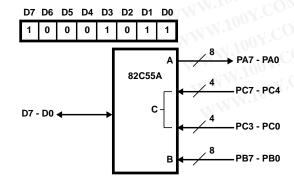
CONTROL WORD #6



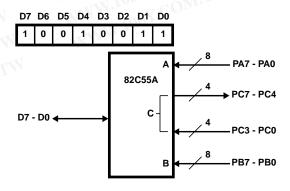
CONTROL WORD #10



CONTROL WORD #7

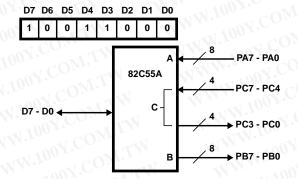


CONTROL WORD #11

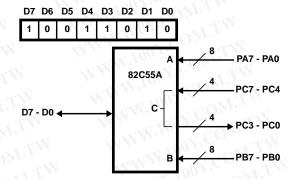


Mode 0 Configurations (Continued)

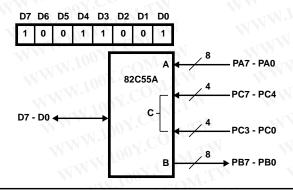
CONTROL WORD #12



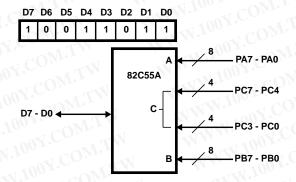
CONTROL WORD #14



CONTROL WORD #13



CONTROL WORD #15



Operating Modes

Mode 1 - (Strobed Input/Output). This functional configuration provides a means for transferring I/O data to or from a specified port in conjunction with strobes or "hand shaking" signals. In mode 1, port A and port B use the lines on port C to generate or accept these "hand shaking" signals.

Mode 1 Basic Function Definitions:

- Two Groups (Group A and Group B)
- Each group contains one 8-bit port and one 4-bit control/data port
- The 8-bit data port can be either input or output. Both inputs and outputs are latched.
- The 4-bit port is used for control and status of the 8-bit port.

Input Control Signal Definition

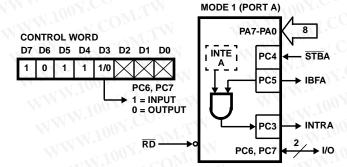
(Figures 6 and 7)

STB (Strobe Input)

A "low" on this input loads data into the input latch.

IBF (Input Buffer Full F/F)

A "high" on this output indicates that the data has been loaded into the input latch: in essence, and acknowledgment. IBF is set by \overline{STB} input being low and is reset by the rising edge of the \overline{RD} input.



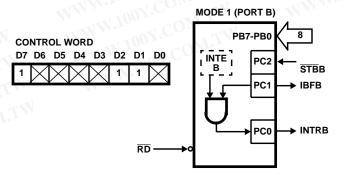


FIGURE 6. MODE 1 INPUT

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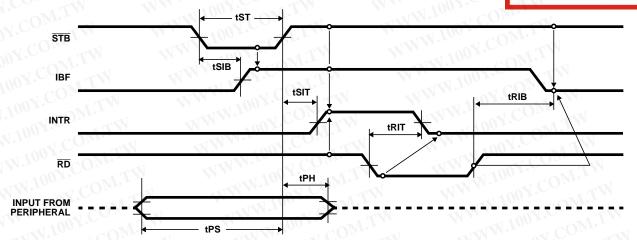


FIGURE 7. MODE 1 (STROBED INPUT)

INTR (Interrupt Request)

A "high" on this output can be used to interrupt the CPU when and input device is requesting service. INTR is set by the condition: $\overline{\text{STB}}$ is a "one", IBF is a "one" and INTE is a "one". It is reset by the falling edge of $\overline{\text{RD}}$. This procedure allows an input device to request service from the CPU by simply strobing its data into the port.

INTE A

Controlled by bit set/reset of PC4.

INTE B

Controlled by bit set/reset of PC2.

Output Control Signal Definition

(Figure 8 and 9)

OBF - Output Buffer Full F/F). The OBF output will go "low" to indicate that the CPU has written data out to be specified port. This does not mean valid data is sent out of the part at this time since OBF can go true before data is available. Data is guaranteed valid at the rising edge of OBF, (See Note 1). The OBF F/F will be set by the rising edge of the WR input and reset by ACK input being low.

ACK - Acknowledge Input). A "low" on this input informs the 82C55A that the data from Port A or Port B is ready to be accepted. In essence, a response from the peripheral device indicating that it is ready to accept data, (See Note 1).

INTR - (Interrupt Request). A "high" on this output can be used to interrupt the CPU when an output device has accepted data transmitted by the CPU. INTR is set when \overline{ACK} is a "one", OBF is a "one" and INTE is a "one". It is reset by the falling edge of \overline{WR} .

INTE A

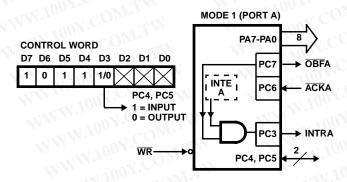
Controlled by Bit Set/Reset of PC6.

INTE B

Controlled by Bit Set/Reset of PC2.

NOTE:

 To strobe data into the peripheral device, the user must operate the strobe line in a hand shaking mode. The user needs to send OBF to the peripheral device, generates an ACK from the peripheral device and then latch data into the peripheral device on the rising edge of OBF.



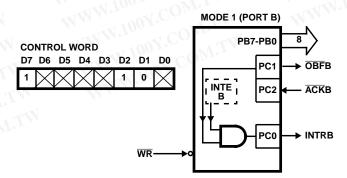


FIGURE 8. MODE 1 OUTPUT

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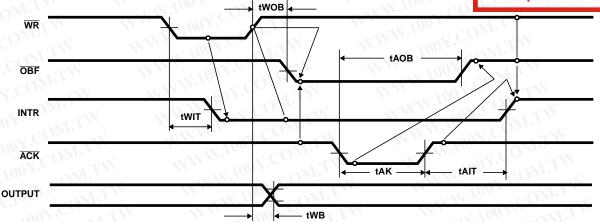
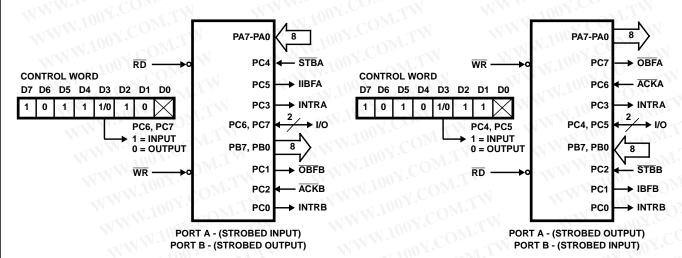


FIGURE 9. MODE 1 (STROBED OUTPUT)



Combinations of Mode 1: Port A and Port B can be individually defined as input or output in Mode 1 to support a wide variety of strobed I/O applications.

FIGURE 10. COMBINATIONS OF MODE 1

Operating Modes

Mode 2 (Strobed Bi-Directional Bus I/O)

The functional configuration provides a means for communicating with a peripheral device or structure on a single 8-bit bus for both transmitting and receiving data (bi-directional bus I/O). "Hand shaking" signals are provided to maintain proper bus flow discipline similar to Mode 1. Interrupt generation and enable/disable functions are also available.

Mode 2 Basic Functional Definitions:

- · Used in Group A only
- One 8-bit, bi-directional bus Port (Port A) and a 5-bit control Port (Port C)
- · Both inputs and outputs are latched
- The 5-bit control port (Port C) is used for control and status for the 8-bit, bi-directional bus port (Port A)

Bi-Directional Bus I/O Control Signal Definition (Figures 11, 12, 13, 14)

INTR - (Interrupt Request). A high on this output can be used to interrupt the CPU for both input or output operations.

Output Operations

OBF - (Output Buffer Full). The **OBF** output will go "low" to indicate that the CPU has written data out to port A.

ACK - (Acknowledge). A "low" on this input enables the three-state output buffer of port A to send out the data. Otherwise, the output buffer will be in the high impedance state.

INTE 1 - (The INTE flip-flop associated with $\overline{\text{OBF}}$). Controlled by bit set/reset of PC4.

Input Operations

STB - (Strobe Input). A "low" on this input loads data into the input latch.

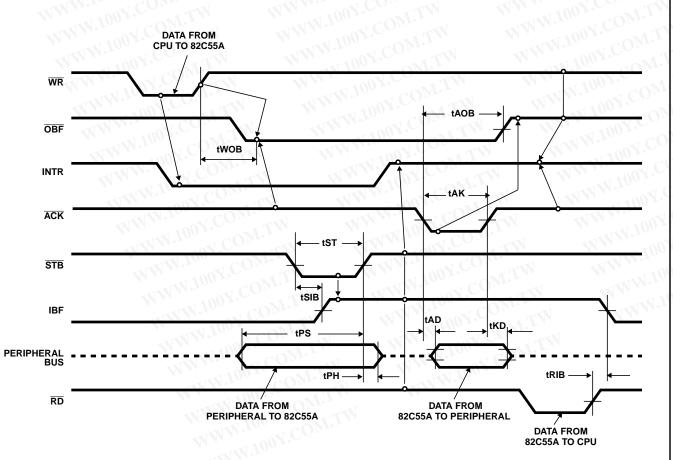
IBF - (Input Buffer Full F/F). A "high" on this output indicates that data has been loaded into the input latch.

INTE 2 - (The INTE flip-flop associated with IBF). Controlled by bit set/reset of PC4.

FIGURE 12. MODE 2

CONTROL WORD D7 D6 D5 D4 D3 D2 D1 D0 ► INTRA PC3 1/0 1/0 1/0 PA7-PA0 PC7 OBFA PC2-PC0 1 = INPUT 0 = OUTPUT PC6 - ACKA .4 INTE 1 PC4 - STBA PORT B 1 = INPUT 0 = OUTPUT PC5 **▶** IBFA WR GROUP B MODE 0 = MODE 0 1 = MODE 1 PC2-PC0 \overline{RD}

FIGURE 11. MODE CONTROL WORD



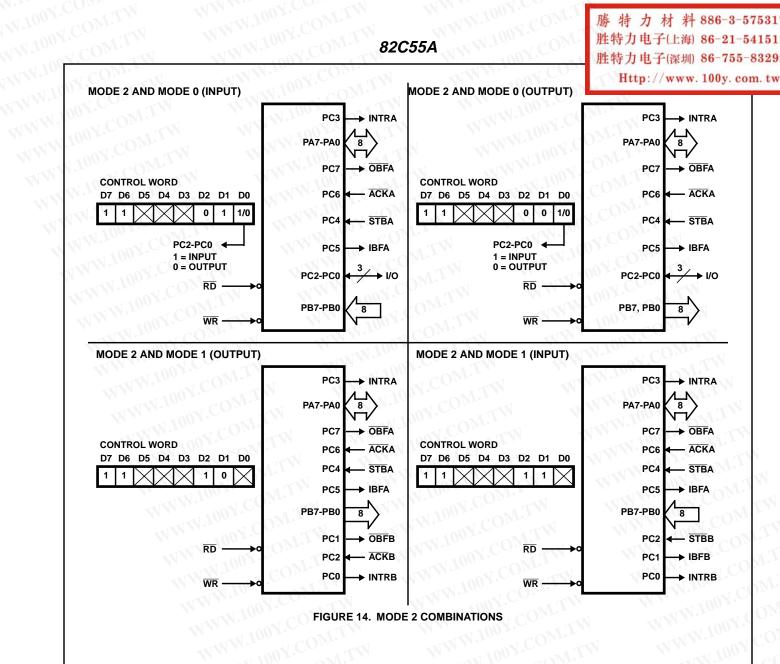
NOTE: Any sequence where \overline{WR} occurs before \overline{ACK} and \overline{STB} occurs before RD is permissible. (INTR = IBF • MASK • \overline{STB} • \overline{RD} ÷ \overline{OBF} • MASK • \overline{ACK} • \overline{WR})

FIGURE 13. MODE 2 (BI-DIRECTIONAL)

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MODE DEFINITION	SUMMARY
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V.COM	MODE 0		MO	DE 1	MODE 2	
ON COM.	IN	OUT	IN	OUT	GROUP A ONLY	1
PA0	ln	Out O	In	Out	COP AND	1
PA1	In	Out	ln	Out	→	
PA2	ln 💮	Out	ln	Out	100 - 100 -	
PA3	In	Out	In	Out		
PA4	In W	Out	In	Out	A CONTRACTOR	
PA5	ln .	Out	ln	Out	- CON	
PA6	In V	Out	In	Out	110000000000000000000000000000000000000	
PA7	ln	Out	CONIn	Out	M COMP	W
PB0	In	Out	ln	Out	M. Ing T. COM.	T _{lat}
PB1	In	Out	ln In	Out	1001.	IN
PB2	ln _t	Out	Qn .	Out	M. J. COL	SN.
PB3	ln	Out	ln In	Out	100 1. COM	Mode 0
PB4	ln In	Out	Cln	Out	TAN M. CO.	Only
PB5	. In	Out	ln In	Out	100 CO	11 9,
PB6	ln N	Out	ln In	Out	M. M. TOOX.CO.	
PB7	In	Out	In OM	Out	TAMM'ION CO	Mr.
PC0	ln.	Out	INTRB	INTRB	1/0	DW.I
PC1	CO In	Out	IBFB	OBFB	I/O	TIN
PC2	_ In	Out	STBB	ACKB	1/0	COMT.
PC3	ln In	Out	INTRA	INTRA	INTRA	
PC4	- In	Out	STBA	I/O	STBA	CON "
PC5	In T	Out	IBFA	1/0	IBFA	"MOD
PC6	In	Out	1/0	ACKA	ACKA	T.Co.
PC7	In .	Out	I/O	OBFA	OBF A	COM

Special Mode Combination Considerations

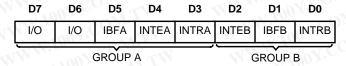
There are several combinations of modes possible. For any combination, some or all of Port C lines are used for control or status. The remaining bits are either inputs or outputs as defined by a "Set Mode" command.

During a read of Port C, the state of all the Port C lines, except the \overline{ACK} and \overline{STB} lines, will be placed on the data bus. In place of the \overline{ACK} and \overline{STB} line states, flag status will appear on the data bus in the PC2, PC4, and PC6 bit positions as illustrated by Figure 17.

Through a "Write Port C" command, only the Port C pins programmed as outputs in a Mode 0 group can be written. No other pins can be affected by a "Write Port C" command, nor can the interrupt enable flags be accessed. To write to any Port C output programmed as an output in Mode 1 group or to change an interrupt enable flag, the "Set/Reset Port C Bit" command must be used.

With a "Set/Reset Port Cea Bit" command, any Port C line programmed as an output (including IBF and \overline{OBF}) can be written, or an interrupt enable flag can be either set or reset. Port C lines programmed as inputs, including \overline{ACK} and \overline{STB} lines, associated with Port C fare not affected by a "Set/Reset Port C Bit" command. Writing to the corresponding Port C bit positions of the \overline{ACK} and \overline{STB} lines with the "Set Reset Port C Bit" command will affect the Group A and Group B interrupt enable flags, as illustrated in Figure 17.

INPUT CONFIGURATION



OUTPUT CONFIGURATION

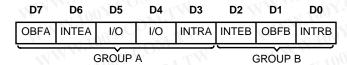
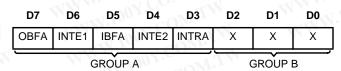


FIGURE 15. MODE 1 STATUS WORD FORMAT



(Defined by Mode 0 or Mode 1 Selection)

FIGURE 16. MODE 2 STATUS WORD FORMAT

Current Drive Capability

Any output on Port A, B or C can sink or source 2.5mA. This feature allows the 82C55A to directly drive Darlington type drivers and high-voltage displays that require such sink or source current.

Reading Port C Status (Figures 15 and 16)

In Mode 0, Port C transfers data to or from the peripheral device. When the 82C55A is programmed to function in Modes 1 or 2, Port C generates or accepts "hand shaking" signals with the peripheral device. Reading the contents of Port C allows the programmer to test or verify the "status" of each peripheral device and change the program flow accordingly.

There is not special instruction to read the status information from Port C. A normal read operation of Port C is executed to perform this function.

INTERRUPT ENABLE FLAG	POSITION	ALTERNATE PORT C PIN SIGNAL (MODE)
INTE B	PC2	ACKB (Output Mode 1) or STBB (Input Mode 1)
INTE A2	PC4	STBA (Input Mode 1 or Mode 2)
INTE A1	PC6	ACKA (Output Mode 1 or Mode 2)

FIGURE 17. INTERRUPT ENABLE FLAGS IN MODES 1 AND 2

Applications of the 82C55A

The 82C55A is a very powerful tool for interfacing peripheral equipment to the microcomputer system. It represents the optimum use of available pins and flexible enough to interface almost any I/O device without the need for additional external logic.

Each peripheral device in a microcomputer system usually has a "service routine" associated with it. The routine manages the software interface between the device and the CPU. The functional definition of the 82C55A is programmed by the I/O service routine and becomes an extension of the system software. By examining the I/O devices interface characteristics for both data transfer and timing, and matching this information to the examples and tables in the detailed operational description, a control word can easily be developed to initialize the 82C55A to exactly "fit" the application. Figures 18 through 24 present a few examples of typical applications of the 82C55A.

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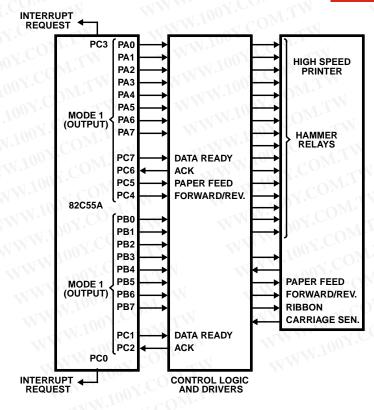
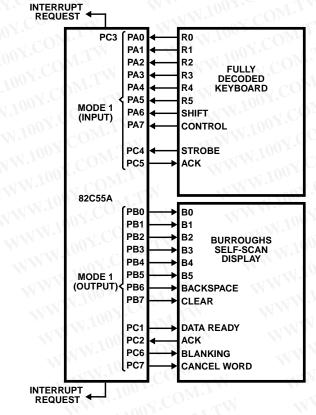


FIGURE 18. PRINTER INTERFACE

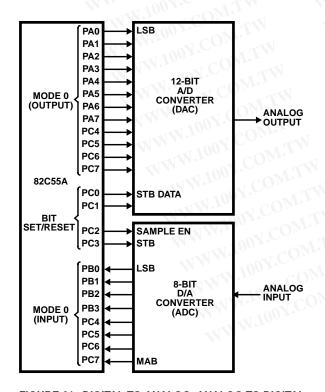


INTERRUPT REQUEST PC3 PAO R0 PA1 R1 PA2 R2 FULLY DECODED PA3 R3 PA4 R4 KEYBOARD PA₅ R5 MODE 1 PA6 SHIFT (INPUT) PA7 CONTROL PC4 **STROBE** PC5 82C55A ACK **BUST LT** PC6 **TEST LT** PC7 PB0 **TERMINAL** ADDRESS PB₁ PB2 PB3 MODE 0 PB4 (INPUT) PB5 PB6 PB7

FIGURE 19. KEYBOARD AND DISPLAY INTERFACE

FIGURE 20. KEYBOARD AND TERMINAL ADDRESS INTERFACE

INTERRUPT



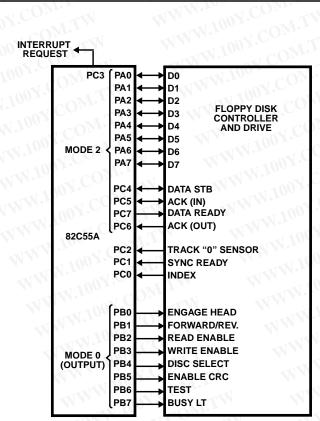
REQUEST PC3 PA0 R0 PA1 R1 PA2 R2 **CRT CONTROLLER** PA3 R3 • CHARACTER GEN. PA4 • REFRESH BUFFER R4 PA5 R5 CURSOR CONTROL MODE 1 PA6 SHIFT (OUTPUT) PA7 CONTROL PC7 DATA READY PC6 ACK PC5 **BLANKED** PC4 **BLACK/WHITE** 82C55A PC2 **ROW STB** PC1 **COLUMN STB** PC0 **CURSOR H/V STB** PB0 PB1 MODE 0 (OUTPUT) PB2 CURSOR/ROW/COLUMN PB3 ADDRESS H&V PB4 PR5 PB6 PB7

FIGURE 21. DIGITAL TO ANALOG, ANALOG TO DIGITAL

FIGURE 22. BASIC CRT CONTROLLER INTERFACE

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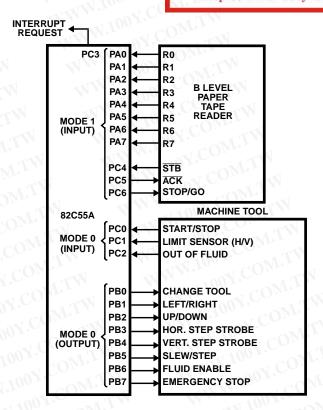


FIGURE 24. MACHINE TOOL CONTROLLER INTERFACE

82C55A

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Absolute Maximum Ratings $T_A = 25^{\circ}C$

Supply Voltage	+8.0V
Input, Output or I/O Voltage	GND-0.5V to V _{CC} +0.5V
ESD Classification	Class 1

Operating Conditions

Voltage Range	+4.5V to 5.5V
Operating Temperature Range	
C82C55A	0°C to 70°C
I82C55A	40°C to 85°C
M82C55A	55°C to 125°C

Thermal Information

Thermal Resistance (Typical, Note 1)	θ_{JA}	$\theta_{\sf JC}$
CERDIP Package	50°C/W	10°C/W
CLCC Package	65°C/W	14 ^o C/W
PDIP Package	50°C/W	N/A
PLCC Package	46°C/W	N/A
Maximum Storage Temperature Range	65	^o C to 150 ^o C
Maximum Junction Temperature		
CDIP Package		175 ⁰ C
PDIP Package	· · · · · · · · · · · · · · · · · · ·	150 ^o C
Maximum Lead Temperature (Soldering 10 (PLCC Lead Tips Only)	Os)	300°C

Die Characteristics

Gate Count

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

1. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications

$$V_{CC}$$
 = 5.0V ±10%; T_A = 0°C to +70°C (C82C55A); T_A = -40°C to +85°C (I82C55A); T_A = -55°C to +125°C (M82C55A)

11	PARAMETER	LIN	IITS	UNITS	TW WWW.100Y.CO.
SYMBOL		MIN	MAX		TEST CONDITIONS
V_{IH}	Logical One Input Voltage	2.0 2.2	MATAN.	100 Y.C	I82C55A, C82C55A, M82C55A
V _{IL}	Logical Zero Input Voltage	-	0.8	1.1V	CONTAIN WAYN TOO Y
V _{OH}	Logical One Output Voltage	3.0 V _{CC} -0.4	MAN	V	I _{OH} = -2.5mA, I _{OH} = -100μA
V _{OL}	Logical Zero Output Voltage	TV	0.4	VVV	I _{OL} +2.5mA
I _I	Input Leakage Current	-1.0	+1.0	μА	V _{IN} = V _{CC} or GND, DIP Pins: 5, 6, 8, 9, 35, 36
Ю	I/O Pin Leakage Current	-10	+10	μΑ	VO = V _{CC} or GND DIP Pins: 27 - 34
IBHH	Bus Hold High Current	-50	-400	μА	VO = 3.0V. Ports A, B, C
IBHL	Bus Hold Low Current	50	400	μА	VO = 1.0V. Port A ONLY
IDAR	Darlington Drive Current	-2.5	Note 2, 4	mA	Ports A, B, C. Test Condition 3
ICCSB	Standby Power Supply Current	V.CO	10	μА	V_{CC} = 5.5V, V_{IN} = V_{CC} or GND. Output Open
ICCOP	Operating Power Supply Current	N.CO	1	mA/MHz	$T_A = +25^{\circ}C$, $V_{CC} = 5.0V$, Typical (See Note 3)

NOTES:

- 2. No internal current limiting exists on Port Outputs. A resistor must be added externally to limit the current.
- 3. ICCOP = 1mA/MHz of Peripheral Read/Write cycle time. (Example: 1.0µs I/O Read/Write cycle time = 1mA).
- 4. Tested as V_{OH} at -2.5mA.

Capacitance $T_A = 25^{\circ}C$

SYMBOL	PARAMETER	TYPICAL	UNITS	TEST CONDITIONS
CIN	Input Capacitance	10	pF	FREQ = 1MHz, All Measurements are referenced to device GND
CI/O	I/O Capacitance	20	pF	Total and to device GNB

82C55A

AC Electrical Specifications V_{CC} = +5V± 10%, GND = 0V; T_A = -55°C to +125°C (M82C55A) (M82C55A-5); T_A = -40°C to +85°C (I82C55A) (I82C55A-5); T_A = 0°C to +70°C (C82C55A) (C82C55A-5)

SYMBOL	PARAMETER	82C55A-5		82C55A		TW	TEST
		MIN	MAX	MIN	MAX	UNITS	CONDITIONS
READ TIMINO	W.Inc.	COM	(X)	WWW	To-	COM.	W
(1) tAR	Address Stable Before RD	COO	- N	0	W.Too	ns	TW
(2) tRA	Address Stable After RD	COM.	T N	0	W.100	ns	TW
(3) tRR	RD Pulse Width	250	3.44	150	N.M.101	ns	
(4) tRD	Data Valid From RD		200	- 33	120	ns	M. I
(5) tDF	Data Float After RD	10	75	10	75	ns	2
(6) tRV	Time Between RDs and/or WRs	300	$O_{M,I,I}$	300	TO VI	ns	OWIT
WRITE TIMIN	IGO MATA	N.1001.	COM.I.	N -≼1	TIN	N.100	$co_{M.1}$
(7) tAW	Address Stable Before WR	1003	COM	0	111	ns	COMI
(8) tWA	Address Stable After WR	20	MOD	20	-	ns	COMIT
(9) tWW	WR Pulse Width	100	7.00	100	- 44	ns	COM.
(10) tDW	Data Valid to WR High	100	07.0	100	- 4	ns	M. COM
(11) tWD	Data Valid After WR High	30	001.	30	-	ns	1001.
OTHER TIMIN	NG TO THE TOTAL	MAN	100 A.C.	OMITY	N	MAN	1007
(12) tWB	WR = 1 to Output	MAL	350	TIMO	350	ns	N.1007
(13) tIR	Peripheral Data Before RD	0	100Y	0	W -	ns	N.100Y.
(14) tHR	Peripheral Data After RD	0	100	0	TW	ns	100Y.
(15) tAK	ACK Pulse Width	200	100	200	LTN	ns	1007
(16) tST	STB Pulse Width	100	WA	100	MEW	ns	100
(17) tPS	Peripheral Data Before STB High	20	MAN	20	WI-IV	ns	WW 10
(18) tPH	Peripheral Data After STB High	50	MAN	50	ON T	ns	MAN
(19) tAD	ACK = 0 to Output	- N	175	TOOY!	175	√ ns	W1
(20) tKD	ACK = 1 to Output Float	20	250	20	250	ns	2
(21) tWOB	WR = 1 to OBF = 0	TW	150	41.3	150	ns	11
(22) tAOB	ACK = 0 to OBF = 1	TW	150	MAIN	150	ns	1,1
(23) tSIB	STB = 0 to IBF = 1	TW	150	MAIN	150	ns	1
(24) tRIB	$\overline{RD} = 1$ to IBF = 0	JAI.	150	WW.	150	ns	1
(25) tRIT	$\overline{RD} = 0$ to INTR = 0	DM	200	WALM	200	ns	1
(26) tSIT	STB = 1 to INTR = 1	COM	150	-	150	ns	1
(27) tAIT	ACK = 1 to INTR = 1	COM.,	150	-	150	ns	1
(28) tWIT	$\overline{WR} = 0$ to INTR = 0	1 -	200	-	200	ns	1
(29) tRES	Reset Pulse Width	500	-	500	-	ns	1, (Note)

NOTE: Period of initial Reset pulse after power-on must be at least 50μsec. Subsequent Reset pulses may be 500ns minimum.

Timing Waveforms

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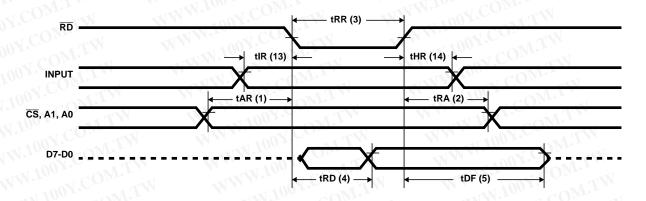
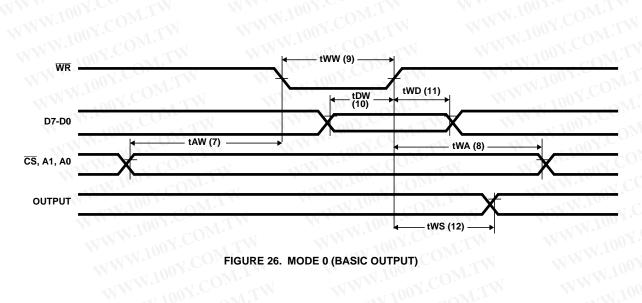


FIGURE 25. MODE 0 (BASIC INPUT)



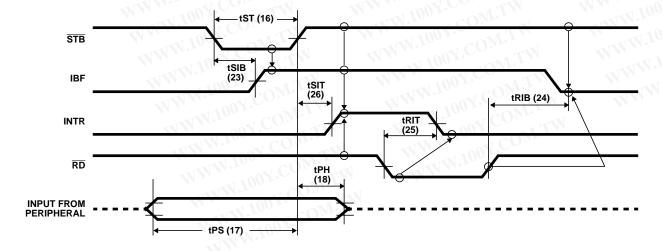


FIGURE 27. MODE 1 (STROBED INPUT)

Timing Waveforms (Continued)

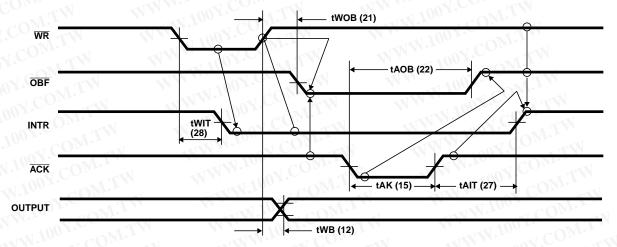


FIGURE 28. MODE 1 (STROBED OUTPUT)

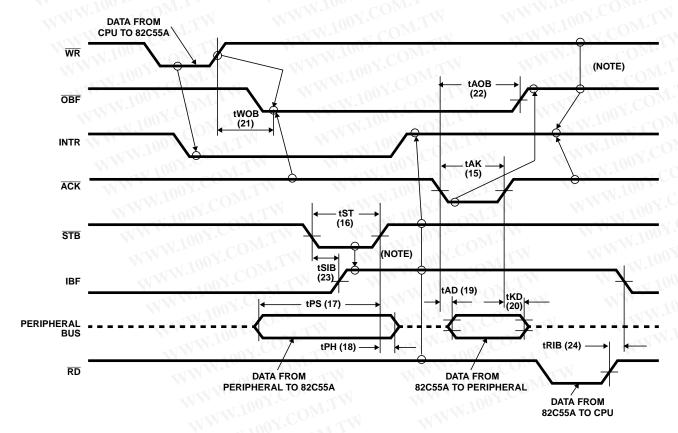
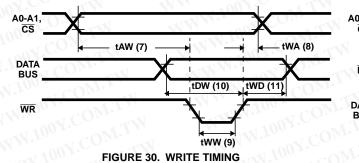


FIGURE 29. MODE 2 (BI-DIRECTIONAL)

NOTE: Any sequence where $\overline{\text{WR}}$ occurs before $\overline{\text{ACK}}$ and $\overline{\text{STB}}$ occurs before $\overline{\text{RD}}$ is permissible. (INTR = IBF • $\overline{\text{MASK}}$ • $\overline{\text{STB}}$ • $\overline{\text{RD}}$ • $\overline{\text{OBF}}$ • $\overline{\text{MASK}}$ • $\overline{\text{ACK}}$ • $\overline{\text{WR}}$)

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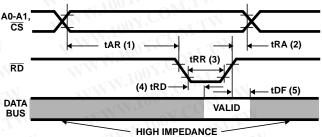
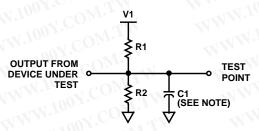


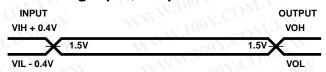
FIGURE 31. READ TIMING

AC Test Circuit



NOTE: Includes STRAY and JIG Capacitance

AC Testing Input, Output Waveforms

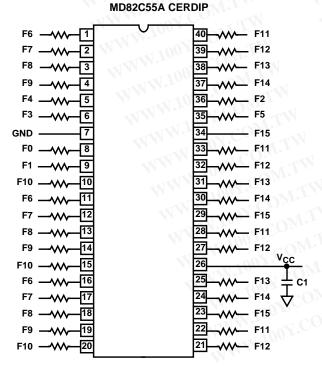


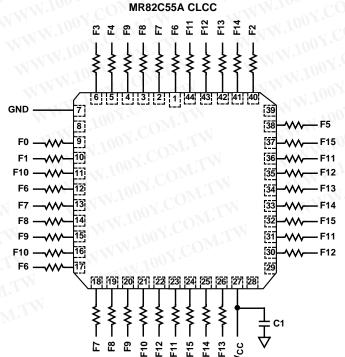
AC Testing: All AC Parameters tested as per test circuits. Input RISE and FALL times are driven at 1ns/V.

TEST CONDITION DEFINITION TABLE

TEST CONDITION	V1	R1	R2	C1
COM	1.7V	523Ω	Open	150pF
2	V _{CC}	2kΩ	1.7kΩ	50pF
100 y 3	1.5V	750Ω	Open	50pF

Burn-In Circuits





NOTES:

- 1. $V_{CC} = 5.5V \pm 0.5V$
- 2. VIH = $4.5V \pm 10\%$
- 3. VIL = -0.2V to 0.4V
- 4. GND = 0V

NOTES:

- 1. $C1 = 0.01 \mu F$ minimum
- 2. All resistors are $47k\Omega\pm5\%$
- 3. $f0 = 100kHz \pm 10\%$
- 4. $f1 = f0 \div 2$; $f2 = f1 \div 2$; . . . ; $f15 = f14 \div 2$

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Die Characteristics

DIE DIMENSIONS:

95 x 100 x 19 ±1 mils

METALLIZATION:

Type: Silicon - Aluminum Thickness: 11kÅ ±1kÅ **GLASSIVATION:**

Type: SiO₂

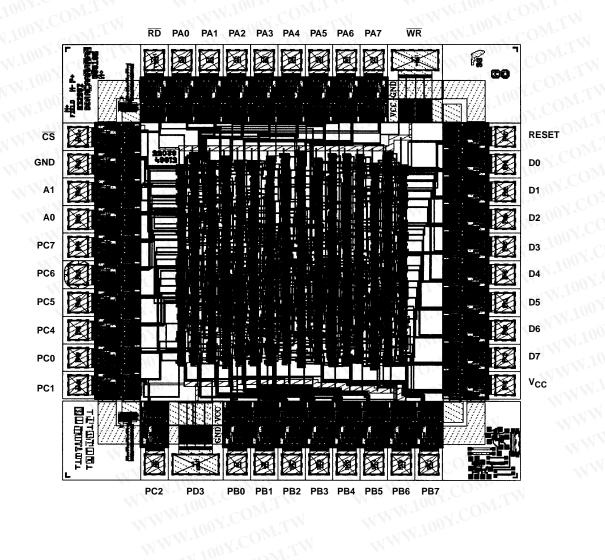
Thickness: 8kÅ ±1kÅ

WORST CASE CURRENT DENSITY:

 $0.78 \times 10^5 \text{ A/cm}^2$

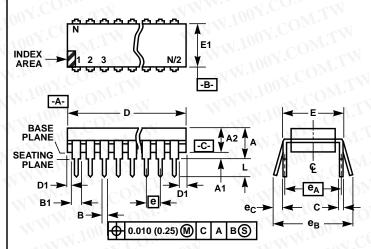
Metallization Mask Layout

82C55A



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Dual-In-Line Plastic Packages (PDIP)



NOTES:

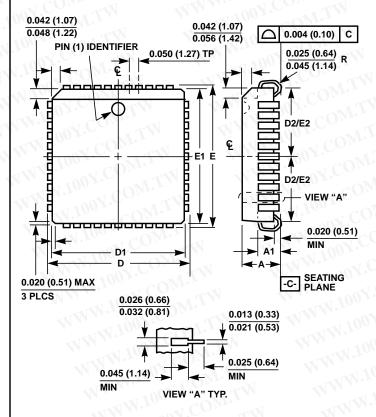
- Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
- 4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
- D, D1, and E1 dimensions do not include mold flash or protrusions.
 Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
- E and e_A are measured with the leads constrained to be perpendicular to datum -C-.
- e_B and e_C are measured at the lead tips with the leads unconstrained. e_C must be zero or greater.
- B1 maximum dimensions do not include dambar protrusions.
 Dambar protrusions shall not exceed 0.010 inch (0.25mm).
- 9. N is the maximum number of terminal positions.
- Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

E40.6 (JEDEC MS-011-AC ISSUE B) 40 LEAD DUAL-IN-LINE PLASTIC PACKAGE

4/	INCHES		MILLIN		
SYMBOL	MIN	MAX	OMIN	MAX	NOTES
Α	Win	0.250	COM	6.35	4
A1	0.015	1 100 %	0.39	1.15	4
A2	0.125	0.195	3.18	4.95	-
В	0.014	0.022	0.356	0.558	-
B1	0.030	0.070	0.77	1.77	8
С	0.008	0.015	0.204	0.381	<u>-</u>
D	1.980	2.095	50.3	53.2	5
D1	0.005	MA	0.13		5
E	0.600	0.625	15.24	15.87	6
E1	0.485	0.580	12.32	14.73	5
е	0.100	BSC	2.54 BSC		1.7.
e _A	0.600	BSC	15.24 BSC		6
e _B	CVI-	0.700	MAIN	17.78	7
	0.115	0.200	2.93	5.08	4
N	4	0	40		9

Rev. 0 12/93

Plastic Leaded Chip Carrier Packages (PLCC)



N44.65 (JEDEC MS-018AC ISSUE A) 44 LEAD PLASTIC LEADED CHIP CARRIER PACKAGE

SYM- BOL	INCHES		MILLIN		
	MIN	MAX	MIN	MAX	NOTES
А	0.165	0.180	4.20	4.57	-
A1	0.090	0.120	2.29	3.04	-
N D	0.685	0.695	17.40	17.65	-
D1	0.650	0.656	16.51	16.66	3
D2	0.291	0.319	7.40	8.10	4, 5
E	0.685	0.695	17.40	17.65	
E1	0.650	0.656	16.51	16.66	3
E2	0.291	0.319	7.40	8.10	4, 5
N	4	4	44		6

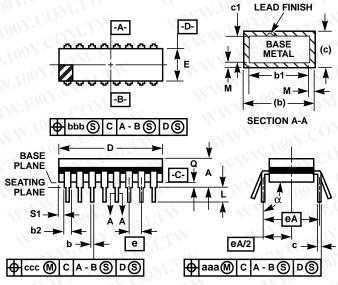
Rev. 2 11/97

NOTES:

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- Controlling dimension: INCH. Converted millimeter dimensions are not necessarily exact.
- 2. Dimensions and tolerancing per ANSI Y14.5M-1982.
- 3. Dimensions D1 and E1 do not include mold protrusions. Allowable mold protrusion is 0.010 inch (0.25mm) per side. Dimensions D1 and E1 include mold mismatch and are measured at the extreme material condition at the body parting line.
- 4. To be measured at seating plane -C- contact point.
- 5. Centerline to be determined where center leads exit plastic body.
- 6. "N" is the number of terminal positions.

Ceramic Dual-In-Line Frit Seal Packages (CERDIP)



NOTES:

- Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
- The maximum limits of lead dimensions b and c or M shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
- 3. Dimensions b1 and c1 apply to lead base metal only. Dimension M applies to lead plating and finish thickness.
- Corner leads (1, N, N/2, and N/2+1) may be configured with a partial lead paddle. For this configuration dimension b3 replaces dimension b2.
- This dimension allows for off-center lid, meniscus, and glass overrun.
- 6. Dimension Q shall be measured from the seating plane to the base plane.
- 7. Measure dimension S1 at all four corners.
- 8. N is the maximum number of terminal positions.
- 9. Dimensioning and tolerancing per ANSI Y14.5M 1982.
- 10. Controlling dimension: INCH.

F40.6 MIL-STD-1835 GDIP1-T40 (D-5, CONFIGURATION A) 40 LEAD CERAMIC DUAL-IN-LINE FRIT SEAL PACKAGE

	INCHES		MILLI		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
Α	- TXN	0.225	COM	5.72	-
b	0.014	0.026	0.36	0.66	2
b1	0.014	0.023	0.36	0.58	3
b2	0.045	0.065	1.14	1.65	-
b3	0.023	0.045	0.58	1.14	4
С	0.008	0.018	0.20	0.46	2
c1	0.008	0.015	0.20	0.38	3
D	· -	2.096	1007	53.24	5
OE	0.510	0.620	12.95	15.75	5
е	0.100 BSC		2.54 BSC		T SAN
eA	0.600 BSC		15.24 BSC		11.1
eA/2	0.300 BSC		7.62 BSC		WIN
V.CO	0.125	0.200 <	3.18	5.08	TI
Q	0.015	0.070	0.38	1.78	6
S1	0.005	<u>-</u>	0.13	1.100	07
α	90°	105 ⁰	90°	105 ⁰	COM
aaa	117	0.015	17 11	0.38	1.0
bbb	CODA	0.030	-WV	0.76	V.CO
ccc	$^{\iota}$ CO $_{M_{I}}$.	0.010		0.25	V.CO
M	CON	0.0015	- 1	0.038	2, 3
N 4	4	0		40	8

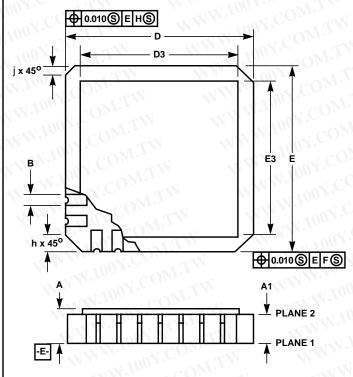
Rev. 0 4/94

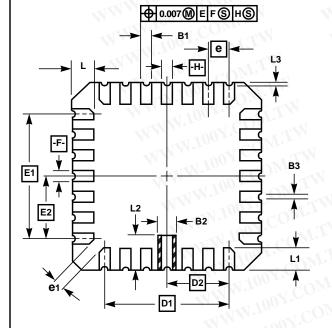
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Ceramic Leadless Chip Carrier Packages (CLCC)





J44.A MIL-STD-1835 CQCC1-N44 (C-5)
44 PAD CERAMIC LEADLESS CHIP CARRIER PACKAGE

SYMBOL	INCHES		MILLI		
	MIN	MAX	MIN	MAX	NOTES
Α	0.064	0.120	1.63	3.05	6, 7
A1	0.054	0.088	1.37	2.24	-
В	0.033	0.039	0.84	0.99	4
B1	0.022	0.028	0.56	0.71	2, 4
B2	0.072	REF	1.83	3 REF	-
B3	0.006	0.022	0.15	0.56	- T
D	0.640	0.662	16.26	16.81	-
D1	0.500	BSC	12.7	0 BSC	- N
D2	0.250	BSC	6.35	5 BSC	TVT
D3	-	0.662	W.100	16.81	2
E	0.640	0.662	16.26	16.81	TIL
E1	0.500	BSC	12.70 BSC		N.F. Y.
E2	0.250	BSC	6.35 BSC		- 17
E3-	M.	0.662		16.81	2
е	0.050	BSC	1.27 BSC		COM.
e1	0.015	Ñ -	0.38	100X	2
h (0.040	REF	1.02	1.02 REF	
July 41	0.020	REF	0.51 REF		5
N.100 X	0.045	0.055	1.14	1.40	700
L100	0.045	0.055	1.14	1.40	002.
L2	0.075	0.095	1.90	2.41	ON.C.
L3	0.003	0.015	0.08	0.38	Local C
ND	7.01	1.\\	11		3
NE	00 1	1 M.T.		11	3
N	4	4	N.	44	3

Rev. 0 5/18/94

NOTES:

- Metallized castellations shall be connected to plane 1 terminals and extend toward plane 2 across at least two layers of ceramic or completely across all of the ceramic layers to make electrical connection with the optional plane 2 terminals.
- Unless otherwise specified, a minimum clearance of 0.015 inch (0.38mm) shall be maintained between all metallized features (e.g., lid, castellations, terminals, thermal pads, etc.)
- Symbol "N" is the maximum number of terminals. Symbols "ND" and "NE" are the number of terminals along the sides of length "D" and "E", respectively.
- 4. The required plane 1 terminals and optional plane 2 terminals (if used) shall be electrically connected.
- The corner shape (square, notch, radius, etc.) may vary at the manufacturer's option, from that shown on the drawing.
- 6. Chip carriers shall be constructed of a minimum of two ceramic layers.
- Dimension "A" controls the overall package thickness. The maximum "A" dimension is package height before being solder dipped.
- 8. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- 9. Controlling dimension: INCH.